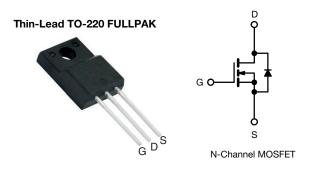
SiHA15N60E

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.28				
Q _g max. (nC)	76				
Q _{gs} (nC)	11				
Q _{gd} (nC)	17				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer
 - Adaptors
 - Televisions
 - Game console
- Computing
 - Adaptors
 - ATX power supply

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free	SiHA15N60E-E3				
Lead (Pb)-free and halogen-free	SiHA15N60E-GE3				

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	- V	
Gate-source voltage			V _{GS}	± 30		
Continuous drain current (T _{.1} = 150 °C) $^{\circ}$	V _{GS} at 10 V	T _C = 25 °C	- I _D	15		
Continuous drain current $(1_j = 150 \text{ C})^\circ$	VGS at 10 V	$T_C = 100 \ ^\circ C$		9.6	А	
Pulsed drain current ^a			I _{DM}	39	1	
Linear derating factor				0.27	W/°C	
Single pulse avalanche energy ^b			E _{AS}	102	mJ	
Maximum power dissipation			PD	34	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	V _{DS} = 0 V to	80 % V _{DS}	d\//d+	70	1//22	
Reverse diode dV/dt ^d			dV/dt	7.7	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 11.6 mH, R_g = 25 Ω , I_{AS} = 4.2 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-		65		•C/W		
Maximum junction-to-case (drain)	R _{thJC}	-	- 3.7					
		1						
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI	
Static		1				I	<u></u>	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.71	-	V/°
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 2	_	2	-	4	v
	00(11)		$V_{GS} = \pm 20$	•	-	_	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$		_	_	± 1	μA
					_	_	1	μ ^μ , ι
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	_	10	μA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V			-	0.23	0.28	Ω
Forward transconductance	g _{fs}		= 30 V, I _D	-	-	4.6	-	S
Dynamic	013		,,		Į			
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1350	-		
Output capacitance	C _{oss}			-	70	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	53	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	177	-	1	
Total gate charge	Qg	V _{GS} = 10 V I _D = 8 A, V _{DS} = 480 V		-	38	76	nC	
Gate-source charge	Q _{gs}			-	11	-		
Gate-drain charge	Q _{gd}			-	17	-		
Turn-on delay time	t _{d(on)}	V_{DD} = 480 V, I_D = 8 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	17	34		
Rise time	t _r			-	51	77	- ns	
Turn-off delay time	t _{d(off)}			-	35	70		
Fall time	t _f			-	33	66		
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.86	1.7	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15		
Pulsed diode forward current	I _{SM}			-	-	60	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 8 A, V _{GS} = 0 V		-	-	1.2	v	
Reverse recovery time	t _{rr}				-	410	-	ns
		T _J = 25 °C, I _F = I _S = 8 A, dl/dt = 100 A/μs, V _B = 20 V			L		I	
Reverse recovery charge	Q _{rr}	$I_{J} = 2$	25 °C, I _F = 1	S = 8 A,	-	5.4	-	μC

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

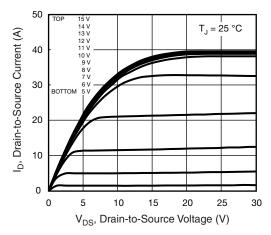


Fig. 1 - Typical Output Characteristics

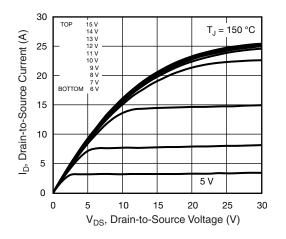


Fig. 2 - Typical Output Characteristics

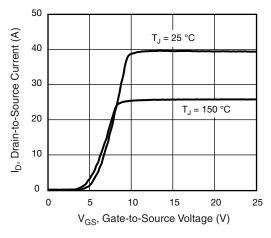


Fig. 3 - Typical Transfer Characteristics

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3 R_{DS(on)}, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 1 = 10 V 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_., Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

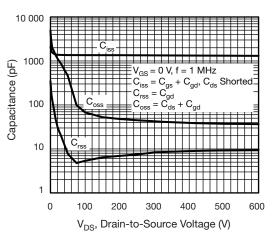


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

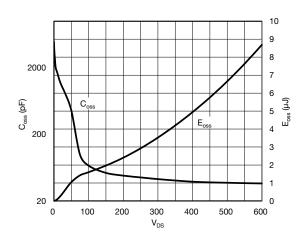


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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3



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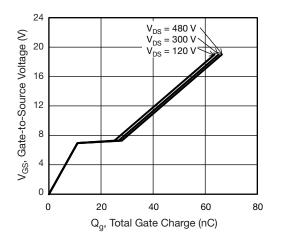


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

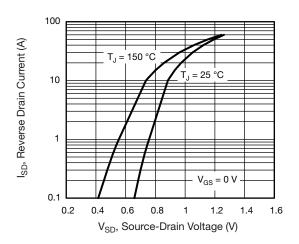


Fig. 8 - Typical Source-Drain Diode Forward Voltage

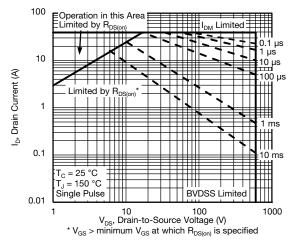


Fig. 9 - Maximum Safe Operating Area

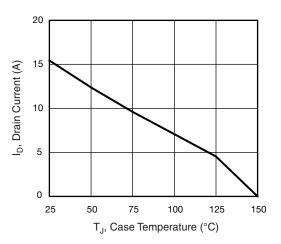


Fig. 10 - Maximum Drain Current vs. Case Temperature

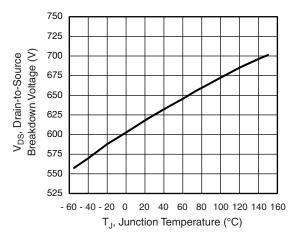


Fig. 11 - Temperature vs. Drain-to-Source Voltage

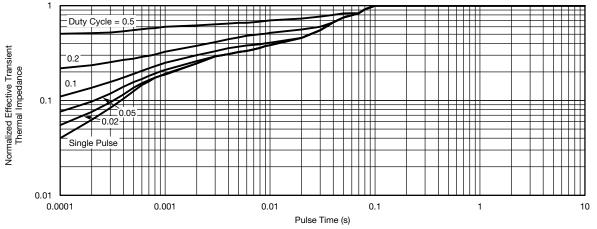
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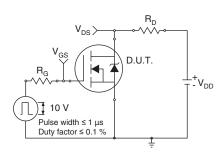


Fig. 13 - Switching Time Test Circuit

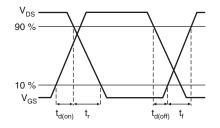


Fig. 14 - Switching Time Waveforms

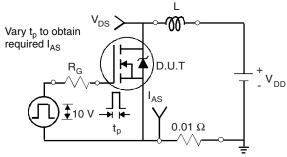


Fig. 15 - Unclamped Inductive Test Circuit

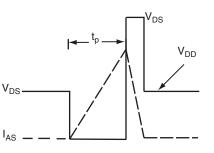


Fig. 16 - Unclamped Inductive Waveforms

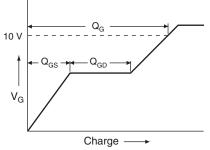


Fig. 17 - Basic Gate Charge Waveform

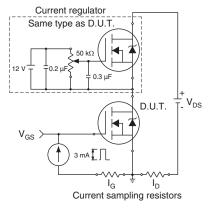


Fig. 18 - Gate Charge Test Circuit

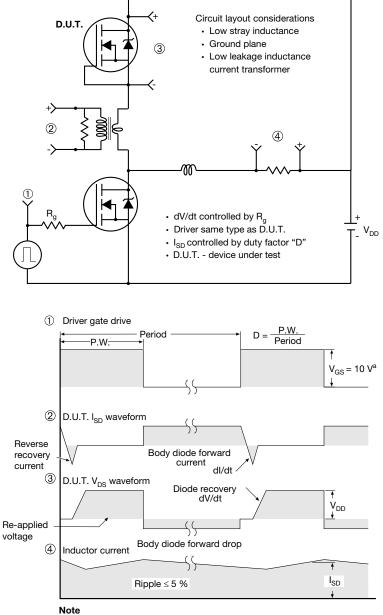
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

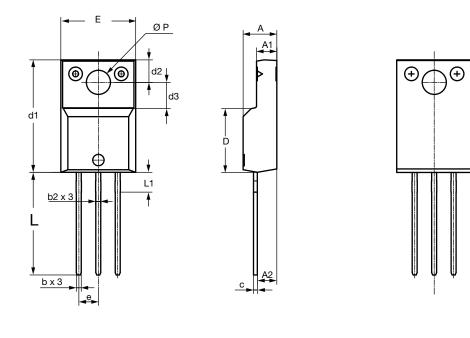
Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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